



DMP2110UVTQ

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> max T <sub>A</sub> = +25°C
	150mΩ @ V <sub>GS</sub> = -4.5V	-1.8A
-20V	200mΩ @ V <sub>GS</sub> = -2.5V	-1.6A
	240mΩ @ V <sub>GS</sub> = -1.8V	-1.4A

### Description

This new generation MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

### **Applications**

- General Purpose Interfacing Switch
- Power Management Functions

#### **DUAL P-CHANNEL ENHANCEMENT MODE MOSFET**

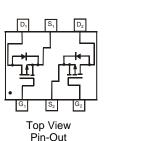
### **Features and Benefits**

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMP2110UVTQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

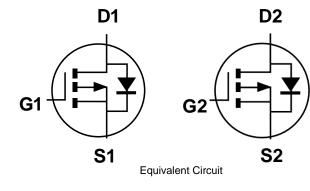
https://www.diodes.com/quality/product-definitions/

### **Mechanical Data**

- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish—Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (@3)
- Weight: 0.013 grams (Approximate)







### Ordering Information (Note 4)

Part Number	Case	Packaging
DMP2110UVTQ-7	TSOT26	3000/Tape & Reel
DMP2110UVTQ-13	TSOT26	10,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

### **Marking Information**

	AR7	M≻
I		

AR7 = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: H = 2020) M = Month (ex: 9 = September)

Date Code	Key
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Year	2019	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	G	Н		J	K	L	М	Ν	0	Р	R	S
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec



## **Maximum Ratings** (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		VDSS	-20	V
Gate-Source Voltage		V <sub>GSS</sub>	±10	V
Drain Current (Note 5) Continuous	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	-1.8 -1.4	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		IDM	-15	A
Body-Diode Continuous Current (Note 5)		ls	-0.7	А

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	0.74	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Roja	168	°C/W
Total Power Dissipation (Note 6)		PD	1.01	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Reja	124	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

### Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)	Symbol	IVIIII	Тур	INIAA	Unit	Test condition
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-20	_	_	V	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250µA
Zero Gate Voltage Drain Current $T_J = +25^{\circ}C$	IDSS	_	_	-1.0	μA	$V_{DS} = -16V, V_{GS} = 0V$
Gate-Source Leakage	IGSS	_	_	±100	nA	$V_{GS} = \pm 8V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)	000				1	
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-0.45	—	-1.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
				150		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -2.8A
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_		200	mΩ	V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -2.0A
	. ,			240		V <sub>GS</sub> = -1.8V, I <sub>D</sub> = -1.0A
Diode Forward Voltage	Vsd	_	—	-1.0	V	VGS = 0V, IS = -1A
DYNAMIC CHARACTERISTICS (Note 8)	•					
Input Capacitance	Ciss	—	443	—	pF	
Output Capacitance	Coss	—	59	—	pF	$V_{DS} = -6V, V_{GS} = 0V$ f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	47	—	pF	1 = 1:00012
Gate Resistance	Rg	_	8.5	—	Ω	$V_{GS} = 0V, V_{DS} = 0V, f = 1.0MHz$
Total Gate Charge	Qg	_	6.0	_	nC	
Gate-Source Charge	Qgs	_	0.6	_	nC	V <sub>GS</sub> = -4.5V, V <sub>DS</sub> = -10V, I <sub>D</sub> = -3A
Gate-Drain Charge	Qgd	_	1.8	_	nC	
Turn-On Delay Time	tD(ON)		4.0	_	ns	
Turn-On Rise Time	tR	_	3.7	_	ns	V <sub>DS</sub> = -10V, V <sub>GS</sub> = -4.5V,
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	24.5	_	ns	$R_L = 10\Omega, R_G = 1.0\Omega, I_D = -1A$
Turn-Off Fall Time	tF	_	9.5	_	ns	7
Reverse Recovery Time	trr	_	8.3	_	ns	I <sub>F</sub> = -1.0A, di/dt = 100A/µs
Reverse Recovery Charge	Q <sub>RR</sub>	_	2.0	_	nC	I <sub>F</sub> = -1.0A, di/dt = 100A/µs

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

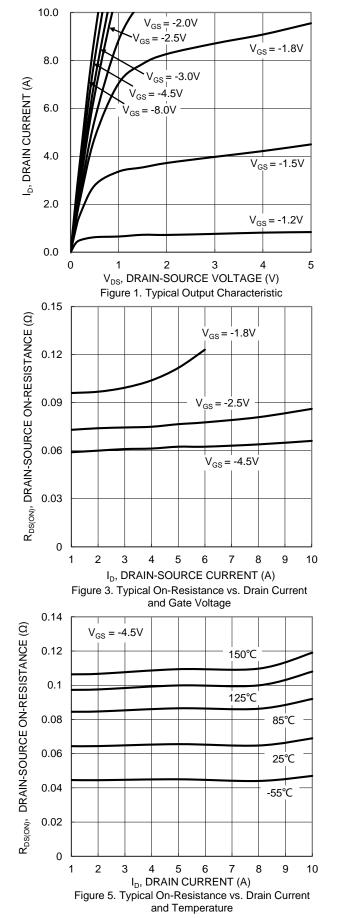
6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

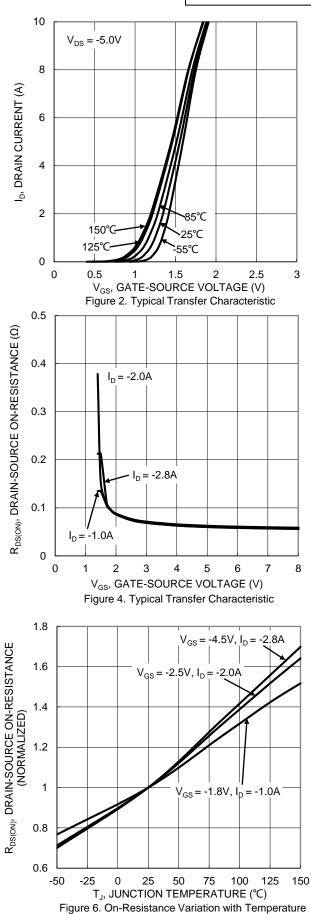
7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.



### DMP2110UVTQ

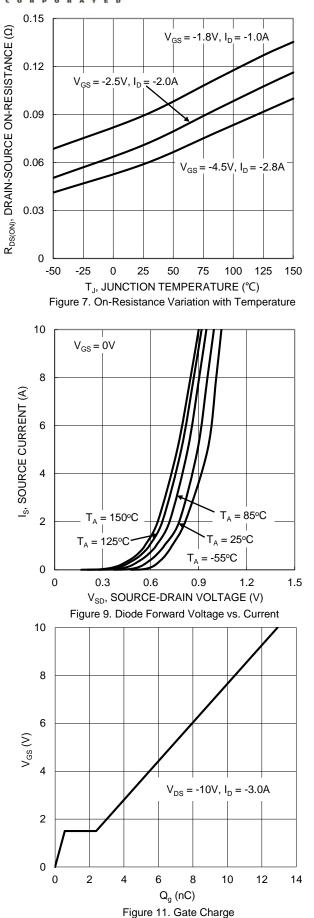


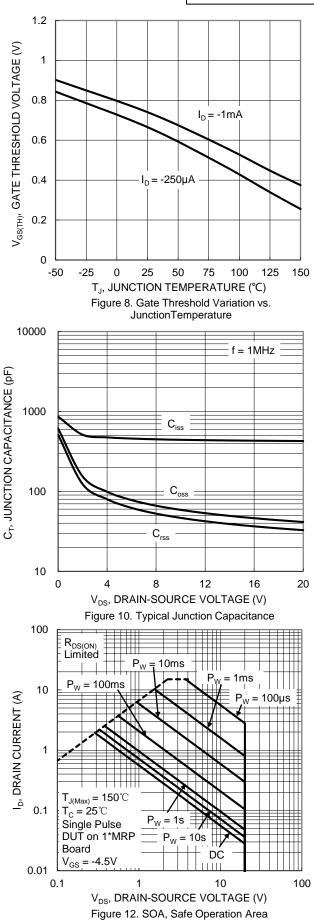


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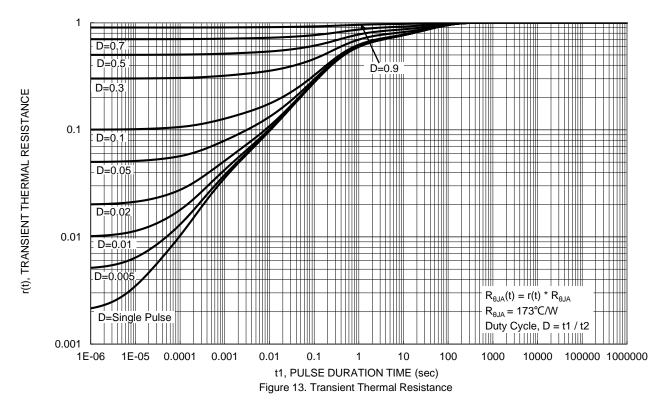








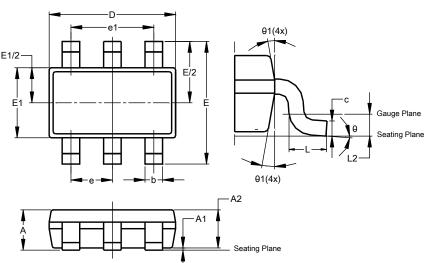






### **Package Outline Dimensions**

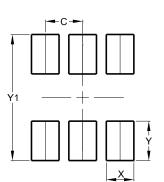
Please see http://www.diodes.com/package-outlines.html for the latest version.



TSOT26						
Dim	Min	Max	Тур			
Α	-	1.00	-			
A1	0.010	0.100	-			
A2	0.840	0.900	-			
D	2.800	3.000	2.900			
ш	2	.800 BS	С			
E1	1.500	1.700	1.600			
b	0.300	0.450	-			
С	0.120	0.200	-			
e	0	.950 BS	С			
e1	1	.900 BS	С			
L	0.30	0.50	-			
L2	0	.250 BS	С			
θ	0°	8°	4°			
θ1	4°	12°	_			
A	II Dimen	sions in	mm			

## Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



TSOT26

TSOT26

Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.200

# E1/2



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